

Installing ALP Software in Win7 Environment

User's Guide



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First download and install the latest Analog LaunchPad Framework Utility on www.ti.com/tool/alp.

- Disconnect the USB connector on the evaluation board and launch ALP Software and click OK button



Figure 0-1.

- Click on the Help button

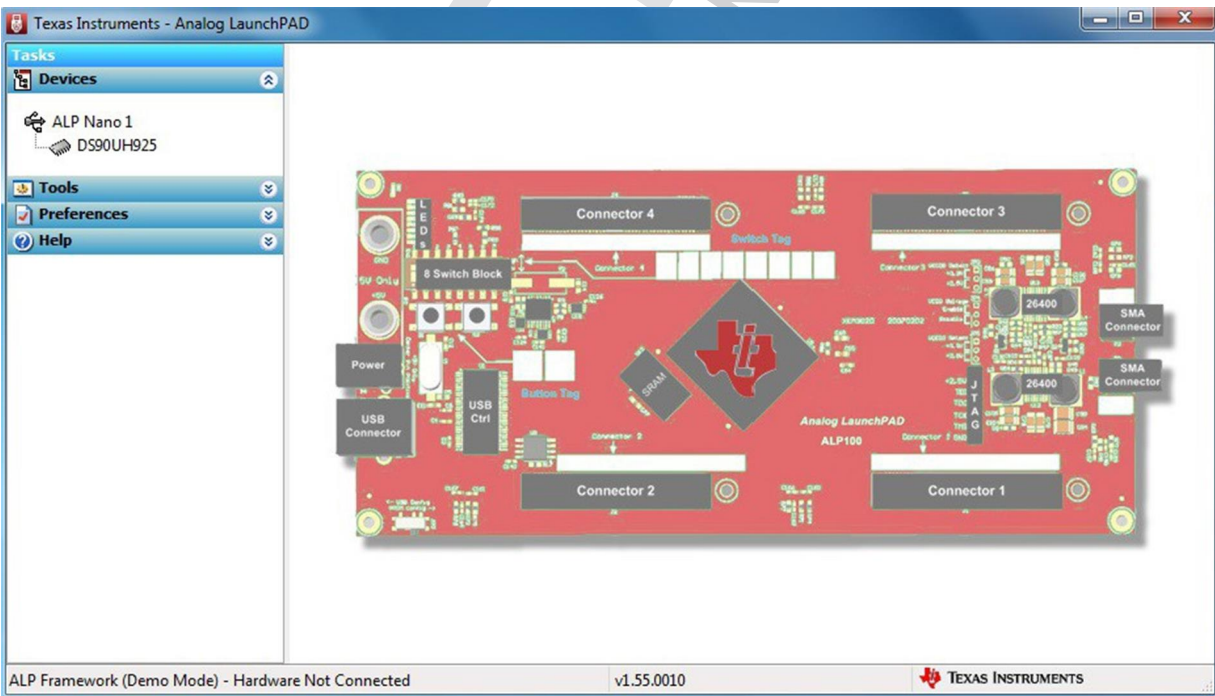


Figure 0-2.

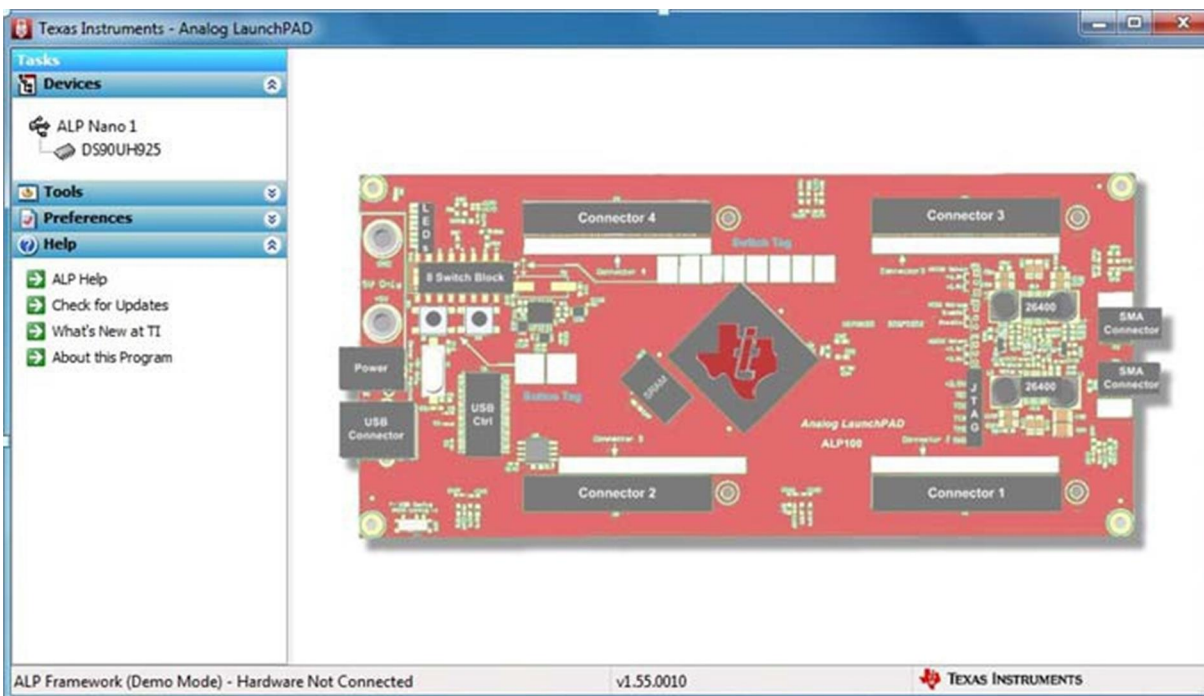


Figure 0-3.

- Select *ALP Help*

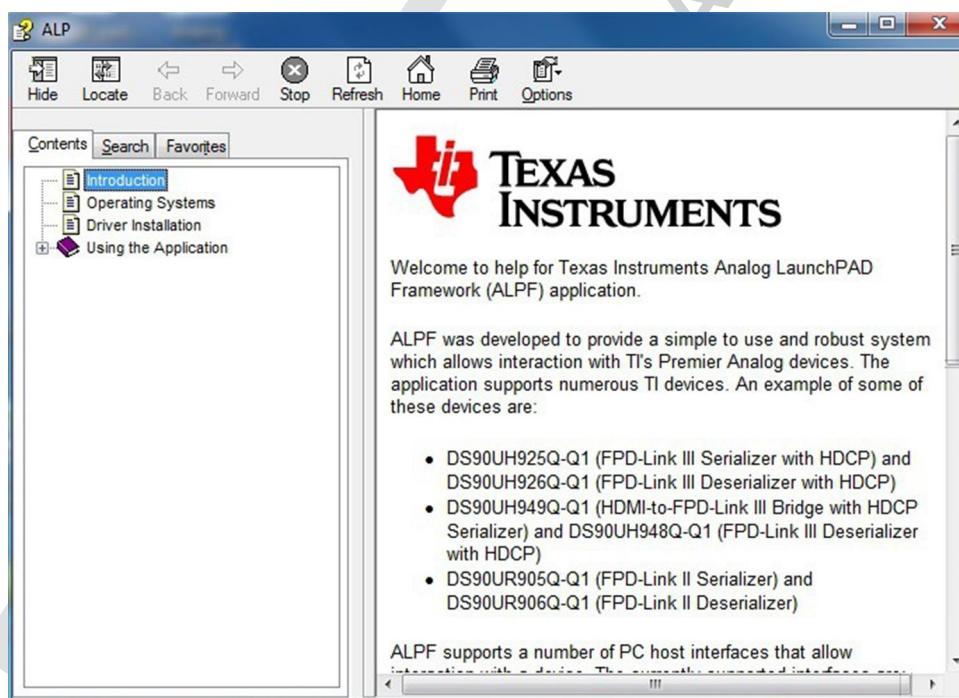


Figure 0-4.

- In the pop up, select *Driver Installation*. Scroll down and follow *Installing NSC USB NANO driver* to install appropriate driver for the win7 environment.

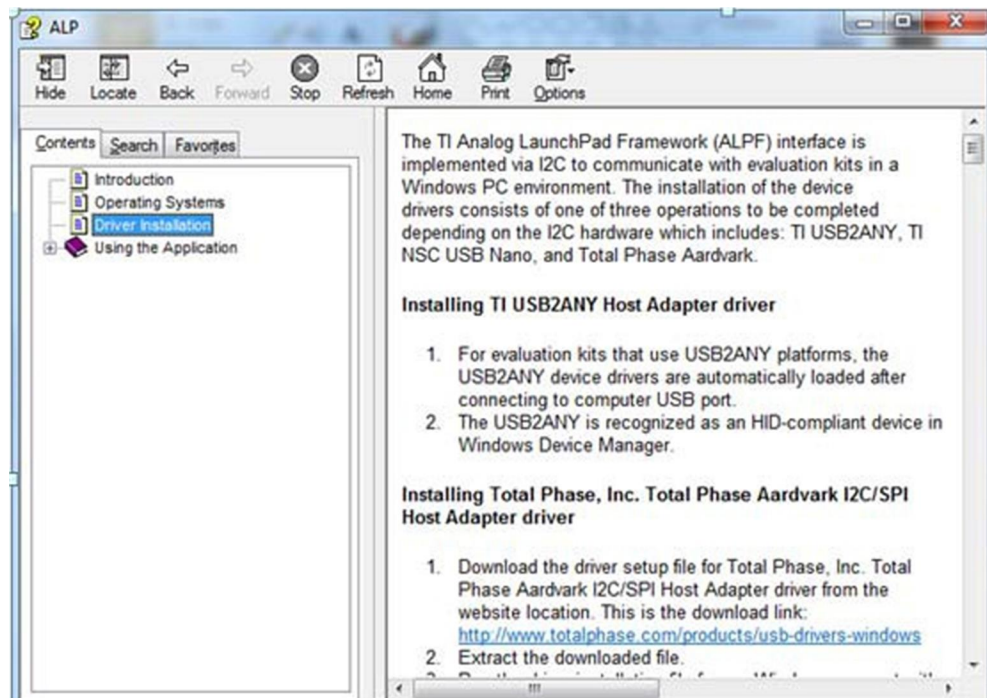


Figure 0-5.

Installing NSC USB NANO driver

The following instructions describe how to install the Cypress CyUSB driver for evaluation kits using the NSC USB Nano platforms on a computer running a Windows 7 (64-bit) operating system.

1. Download the driver file for Cypress CyUSB drivers from the website location. This download link: <http://www.cypress.com/knowledge-base-article/drivers-ez-usb-fx1-fx2lp-and-fx3-kba94413> or [here](#)
2. Extract the downloaded file.
3. Connect the USB connector on the evaluation board to the PC using the USB cable.
4. In Windows 7, select the Device Manager option.
5. In Device Manager, select the category, Universal Serial Bus Controllers. You should see an entry that either has a yellow flag (indicating an unknown device) or an entry labeled "NSC USB NANO"

Figure 0-6.

- Note: In step #5, entry with yellow tag could be in other folder like *Other device* or other folders. When evaluation board USB cable is connected and disconnected, device manager would blink. Find the folder or device that win7 is assigning to the evaluation board.
- Follow steps 6 through 16 of the Driver Installation to install the new driver.

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